L	Hits	Search Text	DB	Time stamp
Number				_
1	0	substrate and mold\$ and alloy and polyster and polycarbonate and lyer and thermoplastic and polyurethane and styrene near butylene\$	USPAT	2004/07/28 12:47
2	0	substrate and mold\$ and alloy and polyster and polycarbonate and lyer and thermoplastic and polyurethane and styrene near butylene\$ and elastomer and polybutylene	USPAT	2004/07/28 12:47
3	0	substrate and mold\$ and alloy and polyster and polycarbonate and lyer and thermoplastic and polyurethane and styrene near4 butylene\$ and elastomer and polybutylene	USPAT	2004/07/28 12:47
4	1	substrate and mold\$ and alloy and polyster and polycarbonate and layer and thermoplastic and polyurethane and styrene near4 butylene\$ and elastomer and polybutylene	USPAT	2004/07/28
5	1	substrate and mold\$ and alloy and polyster and polycarbonate and layer and thermoplastic and polyurethane and styrene near4 butylene\$ and elastomer and polybutylene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/28
6	1	substrate and mold\$ and alloy and polyster and polycarbonate and layer and thermoplastic and polyurethane and styrene near4 butylene\$ and elastomer and polybutylene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/28 12:48
7	73	substrate and mold\$ and alloy and polyester and polycarbonate and layer and thermoplastic and polyurethane and styrene near4 butylene\$ and elastomer and polybutylene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/28 12:50
8	47	substrate and mold\$ and article and alloy and polyester and polycarbonate and layer and thermoplastic and polyurethane and styrene near4 butylene\$ and elastomer and polybutylene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/28 13:11
9	47	substrate and mold\$ and article and alloy and polyester and polycarbonate and layer and thermoplastic and polyurethane and styrene near4 butylene\$ and elastomer and polybutylene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 09:47